

Ryton® R-4-200NA polyphenylene sulfide

Ryton® R-4-200NA and R-4-200BL 40% glass fiber reinforced polyphenylene sulfide compounds provide enhanced mechanical strength and low maintenance molding using conventional molding equipment

Material Status	 Commercial: Active 		
Availability	Asia Pacific	Latin America	
Availability	Europe	North America	
Filler / Reinforcement	Glass Fiber, 40% Filler by Weight		
Features	Good Strength		
Uses	Automotive Applications		
RoHS Compliance	RoHS Compliant		
Automotive Specifications	• FORD WSL-M4D807-A	PSA Peugeot-Citroën SPA X62 5101	
Appearance	Natural Color		
Forms	• Pellets		
Processing Method	 Injection Molding 		
Physical		Typical Value Unit	Test method
Specific Gravity		1.68	ASTM D792
Molding Shrinkage			
Flow: 3.20 mm		0.20 %	
Across Flow: 3.20 mm		0.50 %	
Water Absorption (23°C, 24 hr)		0.020 %	ASTM D570
Mechanical		Typical Value Unit	Test method
Tensile Strength			
		193 MPa	ASTM D638
		200 MPa	ISO 527-2
Tensile Elongation			
Break		1.6 %	ASTM D638
Break		1.7 %	ISO 527-2
Flexural Modulus			
		14500 MPa	ASTM D790
		14000 MPa	ISO 178
Flexural Strength			
		269 MPa	ASTM D790
		285 MPa	ISO 178
Compressive Strength		275 MPa	ASTM D695
Poisson's Ratio		0.40	ISO 527
Impact		Typical Value Unit	Test method
Notched Izod Impact			
3.18 mm		91 J/m	ASTM D256
		9.0 kJ/m ²	ISO 180/A

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Hardness Typical Val	00 20	ASTM D4812 ISO 180 Test method ASTM D785 Test method ASTM D648 ASTM E831
Hardness Typical Val	ue Unit Unit Unit Unit Unit Co Co Co Co Co Co Co Co Co C	Test method ASTM D785 Test method ASTM D648
Hardness Typical Val Rockwell Hardness 1 M-Scale 1 R-Scale 1 Thermal Typical Val Deflection Temperature Under Load 2 1.8 MPa, Unannealed 2 CLTE Flow: -50 to 50°C 1.58 Flow: 100 to 200°C 1.06 Transverse: -50 to 50°C 4.06 Transverse: 100 to 200°C 8.58 Thermal Conductivity 0 UL Temperature Rating 200 to 2 Electrical Typical Val Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.5	ue Unit 00 20 ue Unit 65 °C E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C	Test method ASTM D785 Test method ASTM D648
Rockwell Hardness 1 R-Scale 1 Thermal Typical Val Deflection Temperature Under Load 1.8 MPa, Unannealed 2 CLTE Elow: -50 to 50°C 1.55 Flow: 100 to 200°C 1.06 Transverse: -50 to 50°C 4.06 Transverse: 100 to 200°C 8.56 Thermal Conductivity 0.0 UL Temperature Rating 200 to 2 Electrical Typical Val Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.5	00 20 ue Unit 65 °C E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C	Test method ASTM D648
M-Scale 1 R-Scale 1 Thermal Typical Val Deflection Temperature Under Load 1.8 MPa, Unannealed 2 CLTE Flow: -50 to 50°C 1.55 Flow: 100 to 200°C 1.06 Transverse: -50 to 50°C 4.06 Transverse: 100 to 200°C 8.56 Thermal Conductivity 0.0 UL Temperature Rating 200 to 2 Electrical Typical Val Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.5	ue Unit 65 °C 65 °C 65 °C 65 cm/cm/°C 65 cm/cm/°C 65 cm/cm/°C	Test method ASTM D648
R-Scale 1 Thermal Typical Val Deflection Temperature Under Load 1.8 MPa, Unannealed 2 CLTE Flow: -50 to 50°C 1.58 Flow: 100 to 200°C 1.08 Transverse: -50 to 50°C 4.08 Transverse: 100 to 200°C 8.58 Thermal Conductivity 0.0 UL Temperature Rating 200 to 2 Electrical Typical Val Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.5	ue Unit 65 °C 65 °C 65 °C 65 cm/cm/°C 65 cm/cm/°C 65 cm/cm/°C	ASTM D648
Thermal Deflection Temperature Under Load 1.8 MPa, Unannealed 2 CLTE Flow: -50 to 50°C Flow: 100 to 200°C Transverse: -50 to 50°C Transverse: -50 to 50°C Thermal Conductivity 0.0 UL Temperature Rating 200 to 2 Electrical Typical Val Surface Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz Typical Val Typical Val Typical Val Typical Val Typical Val Surface Resistivity 1.0E+ Dielectric Constant 25°C, 1 kHz	ue Unit 65 °C E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C	ASTM D648
Deflection Temperature Under Load 1.8 MPa, Unannealed 2.2 CLTE Flow: -50 to 50°C Flow: 100 to 200°C Transverse: -50 to 50°C Transverse: 100 to 200°C Thermal Conductivity 0.0 UL Temperature Rating 200 to 2 Electrical Surface Resistivity 1.0E+ Volume Resistivity Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.2	65 °C E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C	ASTM D648
1.8 MPa, Unannealed 2 CLTE Flow: -50 to 50°C 1.58 Flow: 100 to 200°C 1.08 Transverse: -50 to 50°C 4.08 Transverse: 100 to 200°C 8.58 Thermal Conductivity 0.0 UL Temperature Rating 200 to 2 Electrical Typical Val Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.5	E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C	
CLTE Flow: -50 to 50°C 1.5E Flow: 100 to 200°C 1.0E Transverse: -50 to 50°C 4.0E Transverse: 100 to 200°C 8.5E Thermal Conductivity 0. UL Temperature Rating 200 to 2 Electrical Typical Val Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.5E	E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C	ASTM E831
Flow : -50 to 50°C 1.58 Flow : 100 to 200°C 1.08 Transverse : -50 to 50°C 4.08 Thermal Conductivity 0.0 UL Temperature Rating 200 to 2 Electrical Typical Val Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 3.5 25°C, 1 kHz 3.5	E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C	ASTM E831
Flow: 100 to 200°C Transverse: -50 to 50°C Transverse: 100 to 200°C Thermal Conductivity UL Temperature Rating Electrical Surface Resistivity Typical Val Surface Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 1.0E+	E-5 cm/cm/°C E-5 cm/cm/°C E-5 cm/cm/°C	
Transverse: -50 to 50°C Transverse: 100 to 200°C Thermal Conductivity UL Temperature Rating Electrical Surface Resistivity Typical Val Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 4.0E 4.0E Typical Val 1.0E+ 3.0E	E-5 cm/cm/°C E-5 cm/cm/°C	
Transverse: 100 to 200°C Thermal Conductivity UL Temperature Rating Electrical Surface Resistivity Typical Val Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz Typical Val 1.0E+ 3.50 3.5	E-5 cm/cm/°C	
Thermal Conductivity 0.0. UL Temperature Rating 200 to 2 Electrical Typical Val Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.		
UL Temperature Rating 200 to 2 Electrical Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 300 to 2 Typical Val 1.0E+ 1.0E+ 310 310 310 310 310 310 310 31	33 W/m/K	
Electrical Surface Resistivity 1.0E+ Volume Resistivity Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.0E+		
Surface Resistivity 1.0E+ Volume Resistivity 1.0E+ Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.0E+	20 °C	UL 746B
Volume Resistivity Dielectric Strength Dielectric Constant 25°C, 1 kHz 1.0E+	ue Unit	Test method
Dielectric Strength Dielectric Constant 25°C, 1 kHz 3.	16 ohms	ASTM D257
Dielectric Constant 25°C, 1 kHz 3.	16 ohms·cm	ASTM D257
25°C, 1 kHz 3.	22 kV/mm	ASTM D149
		ASTM D150
25°C, 1 MHz 3.	90	
	80	
Dissipation Factor		ASTM D150
25°C, 1 kHz 2.0E	E-3	
25°C, 1 MHz 2.0E	E-3	
Arc Resistance 1	25 sec	ASTM D495
Comparative Tracking Index (CTI)	50 V	UL 746
Insulation Resistance 1 (90°C) 1.0E+	11 ohms	
Flammability Typical Val	ue Unit	Test method
Flame Rating (1.60) mm)	/-0 VA	UL 94
	57 %	ASTM D2863

Ryton® R-4-200NA

polyphenylene sulfide

Notes

Typical properties: these are not to be construed as specifications.

¹ 95%RH, 48 hr

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